

In collaboration with **molex** & **3M** 

# **MPO EBO***EZ-WAY***<sup>™</sup>**

# **EXPANDED BEAM**

Precision connectivity for every application

Push-Pull Boot

**3**M

Low Spring Force

SENKO's MPO EBO EZ-WAY<sup>™</sup> connector incorporates the EZ-WAY<sup>™</sup> push-pull boot feature for high density applications coupled with the non-contact, lensed 3M<sup>™</sup> Expanded Beam Optical ferrule allowing it to be deployed in environments not always suited to the traditional physical contact products.

### Integrating 3M Revolutionary EBO Ferrule Technology

#### FEATURES

- SENKO's push-pull boot suitable for high density applications
- Resistant to dirt, debris, and vibration damage
- Compatible with standard MPO Adapters and SENKO 776 series of MPO SC Footprint adapters
- Designed in collaboration with Molex for interoperability and intermateability
- Non-contact, lensed 3M<sup>™</sup> Expanded Beam Optical ferrule

Push-pull boot for dense patch panels

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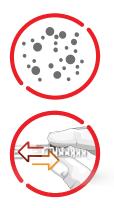




#### MPO EBO EZ-WAY CONNECTOR

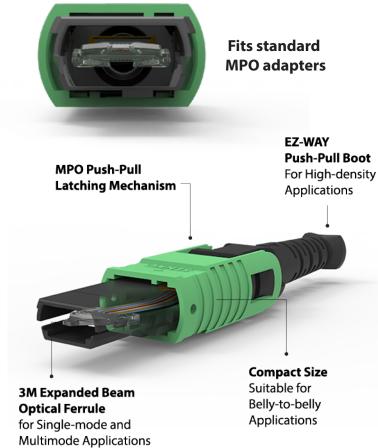
## EXPANDED BEAM PRECISION

The non-contact ferrule ensures it is more resistant to dirt, debris, and damage from vibration, thus ensuring stable and reliable connections over time for optimal network performance. It is also compatible with standard MPO Adapters and the SENKO 776 series of MPO SC Footprint adapters, making it suitable for use in legacy applications and panel designs.



Dust Insensitivity

**Push-pull boot** 



#### **Specifications**

	Singlemode	Multimode
Durability	1000 mating cycles	
Insertion Loss (dB)*	<0.70	<0.30
Typical Return Loss (dB)*	≥55	≥25
*Operating Temperature	-10°C to +60°C	

Based on master grade jumper to low loss random mating test

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